PCN # 1801B DATE: February 27, 2019

EXPECTED PCN SHIP DATE: February 27, 2019



Quality Assurance 160 Rio Robles San Jose, CA 95134

www.maximintegrated.com

## PROCESS CHANGE NOTICE X PRODUCT CHANGE NOTICE

## MAXIM INTEGRATED HEREBY ISSUES NOTIFICATION OF CHANGE THAT MAY AFFECT THE FOLLOWING CATEGORIES:

X DESIGN WAFER FAB	ASSEMBLY	П Т	TEST	ELEC/MECH SPECS
AFFECTED PRODUCT:				
Ordering	P/N: (See PN listin	g XLS in PCN	ZIP file)	
CHANGE FROM: -	C	CHANGE TO: -		
Die design change for MAX9291/MAX9293:				
Current Die ID/Die Revision (HS75A-0C/BKG5)	N	New DieID/Die revision HS75A-0E/BZF5		
		New die has an added High Pass Filter/HPF (resistor and		
	с	apacitor) in the	e serial clock s	signal path between SSPLL buffer
	0	utput and P2S	(parallel-to-se	erial) buffer input
		-	-	· •
ILISTIEIC ATION:				

## JUSTIFICATION: -

To improve the production test yield performance of these devices, a simple metal mask change is required by adding a High Pass Filter/HPF (described above). This change is required to ensure supply chain continuity by eliminating the inconsistent manufacturing yield for max frequency performance. The datasheet electrical table specifications and overall content remain unchanged.

The form, fit and function of these devices are identical before/after the change.

TRACEABILITY: Maxim Integrated maintains full traceability by device marking, packaging labels and shipment documents.

Maxim Integrated's Change Notification System is designed to keep our customer base apprised of major product, manufacturing, or facility improvements.

## Nasser Ali Chaouche

Nasser AliChaouche / PCN Coordinator

For further information, please contact either of the people listed below.

Contact your local Maxim Integrated Company Representative or

Nasser AliChaouche, PCN Coordinator 408-601-5660 / pcn.coordinator@maximintegrated.com